



NOTES:

- MATERIAL:
 - MOLDING: LCP UL94 V-0
 - CONTACT: COPPER ALLOY.
 - GOLD PLATING ALL OVER 50u" Min NICKEL AND 100u" Min Tin ALL OVER 50u" Min NICKEL ON SOLDER AREA
 - SHELL: SUS304-H,T=0.30±0.03mm
 - 50u" NICKEL PLATING OVER ALL.
 - SHILD: SUS304-H,T=0.12±0.03mm
- MECHANICAL:
 - INSERTION: 5~20N.
 - EXTRACTION: 8~20N.
 - DURABILITY: 10000 CYCLES
- ELECTRICAL:
 - CURRENT: 5A MIN FOR VBUS; 0.25A MIN FOR OTHER.
 - VOLTAGE: 5VAC MAX
 - WITHSTANDING VOLTAGE: 100V AC.
 - CONTACT RESISTANCE: 40mΩ MAX.
 - INSULATION RESISTANCE: 100MΩ MIN.
- ENVIRONMENTAL
 - TEMPERATURE RANGE -55°C ~ +85°C

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4	SHILD	SUS304-H	
3	SHELL	SUS304-H	50u" NICKEL PLATING OVER ALL
2	CONTACT	C2680	GOLD PLATING ALL OVER 50u" Min NICKEL AND 100u" Min Tin ALL OVER 50u" Min NICKEL ON SOLDER AREA
1	MOLDING	LCP	UL94V-0
NO.	PART NAME	MATERIAL	DESCRIPTION

HE 东莞市旭明电子有限公司
Dongguan City Xuming Electronics Co. Ltd.

TITLE:	USB C/F 夹板0.8铆合款L10.50 黑LCP外壳不锈钢镀镍			
PART NO.	UCJ0008-000	CUSTOMER NO(REV)	1G	UNIT:mm
FILE NAME	140804-01	SHEET: 1 of 1	SCALE: 1:1	A4

REV	DATE	DESCRIPTION	NAME	APPRO.	0	±0.25	DESIGN	
					0.0	±0.20	CHECK	
0	14'/08/04	NEW	Chi	Captain	0.00	±0.15	APPRO.	
					GENERAL TOLERANCE UNLESS OTHERWISE NOTED			